

SPDT SWITCH GaAs MMIC

■ GENERAL DESCRIPTION

The NJG1647HD3 is a GaAs SPDT switch IC suited for the application of GSM, CDMA and UMTS handsets.

This switch features low distortion, high power handling and low insertion loss.

This device can operate a single bit control signal from +1.3V. This device has the low current consumption mode.

The ultra-small & ultra-thin USB6-D3 package is adopted.

■ PACKAGE OUTLINE



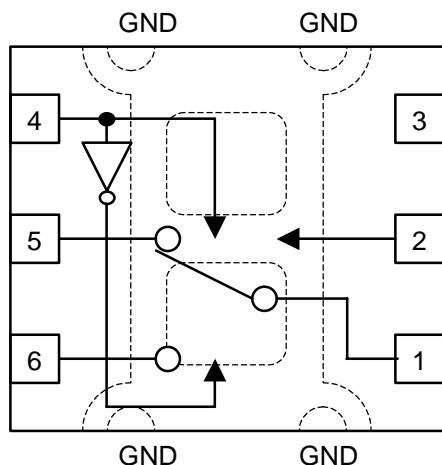
NJG1647HD3

■ FEATURES

- Low control voltage 1.3V min.
- Low operation voltage 2.5~+3.6V
- Low distortion IIP3=+70dBm typ. @ $P_{IN}=24\text{dBm}$, 2 tone, $V_{DD}=2.7\text{V}$
- Low insertion loss 2nd harmonics=-70dBc max. @ $P_{IN}=35\text{dBm}$, $f=0.9\text{GHz}$
- Ultra-small & ultra-thin package 3rd harmonics=-70dBc max. @ $P_{IN}=35\text{dBm}$, $f=0.9\text{GHz}$
0.25dB typ. @ $f=0.9\text{GHz}$, $P_{IN}=35\text{dBm}$, $V_{DD}=2.7\text{V}$
0.30dB typ. @ $f=1.9\text{GHz}$, $P_{IN}=33\text{dBm}$, $V_{DD}=2.7\text{V}$
USB6-D3 (Package size: 2.0x1.8x0.8mm)

■ PIN CONFIGURATION

USB6-D3 Type (Top View)



Pin connection

1. PC
2. CTL2 (Option)
3. VDD
4. CTL1
5. P1
6. P2

■ TRUTH TABLE

$$\text{"H"} = V_{CTL(H)}, \text{"L"} = V_{CTL(L)}$$

| CTL1 | Path |
|------|-------|
| H | P1-PC |
| L | P2-PC |

Option: CTL2 is the mode switching port. Supplying "L" voltage, this device is operated the low current consumption mode.

NOTE: Please note that any information on this datasheet will be subject to change.

■ ABSOLUTE MAXIMUM RATINGS

($T_a=+25^\circ\text{C}$, $Z_s=Z_l=50\Omega$)

| PARAMETER | SYMBOL | CONDITIONS | RATINGS | UNITS |
|-------------------|-----------|--|----------|-------|
| RF Input Power | P_{IN} | $V_{DD}=2.7\text{V}$, $CTL2=V_{CTL(H)}$ | 36 | dBm |
| | | $V_{DD}=2.7\text{V}$, $CTL2=V_{CTL(L)}$ | 32 | |
| Supply Voltage | V_{DD} | VDD terminal | 5.0 | V |
| Control Voltage | V_{CTL} | CTL1, CTL2 terminal | 5.0 | V |
| Power Dissipation | P_D | on PCB board | 270 | mW |
| Operating Temp. | T_{opr} | | -40~+85 | °C |
| Storage Temp. | T_{stg} | | -55~+150 | °C |

■ ELECTRICAL CHARACTERISTICS 1

(General conditions: $T_a=+25^\circ\text{C}$, $Z_s=Z_l=50\Omega$, $V_{DD}=2.7\text{V}$, $V_{CTL(L)}=0\text{V}$, $V_{CTL(H)}=1.8\text{V}$, with application circuit)

| PARAMETERS | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|------------------------|--------------|--------------------------------|-----|-----|-----|-------|
| Supply Voltage | V_{DD} | | 2.5 | 2.7 | 3.6 | V |
| Operating Current1 | I_{DD1} | No RF input, $CTL2=V_{CTL(H)}$ | - | 300 | 500 | µA |
| Operating Current2 | I_{DD2} | No RF input, $CTL2=V_{CTL(L)}$ | - | 15 | 50 | µA |
| Control Voltage (LOW) | $V_{CTL(L)}$ | CTL1, CTL2 Terminal | 0 | - | 0.4 | V |
| Control Voltage (HIGH) | $V_{CTL(H)}$ | CTL1, CTL2 Terminal | 1.3 | - | 5.0 | V |
| Control Current | I_{CTL} | | - | 5 | 10 | µA |

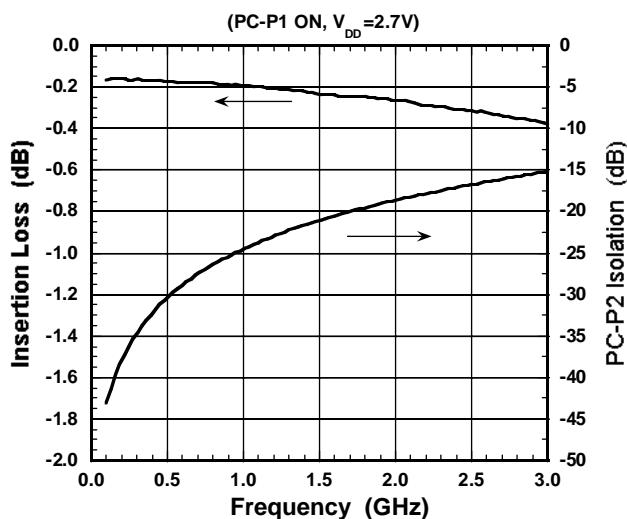
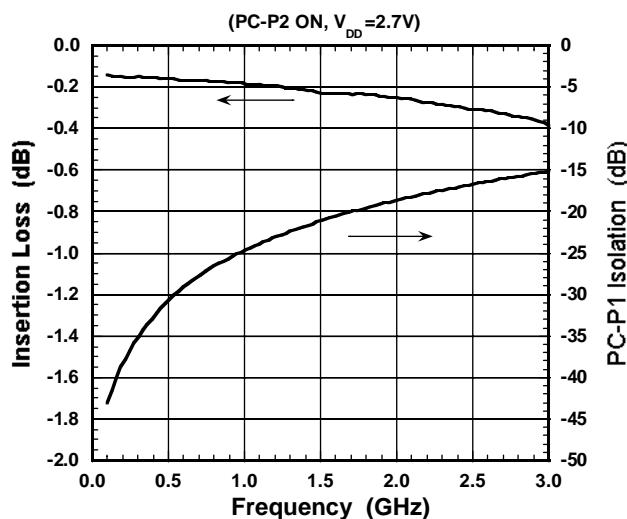
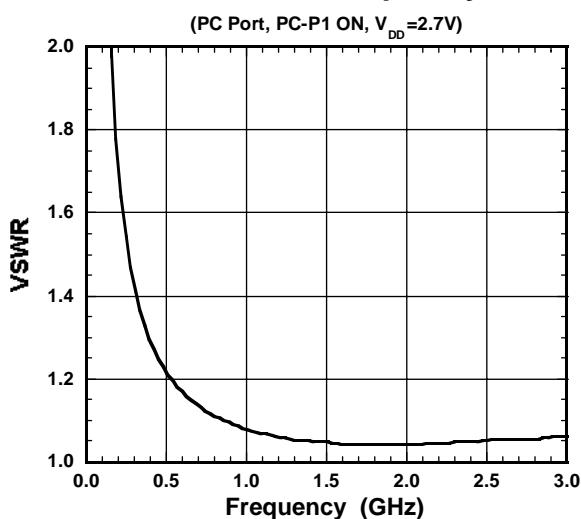
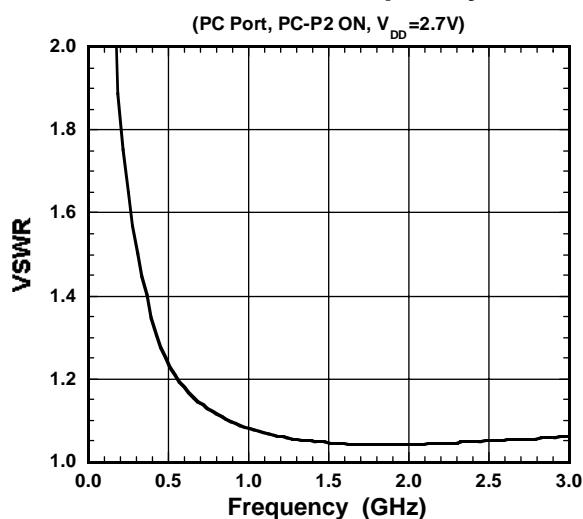
■ ELECTRICAL CHARACTERISTICS 2(General conditions: $T_a=+25^\circ\text{C}$, $Z_s=Z_l=50\Omega$, $V_{DD}=2.7\text{V}$, $V_{CTL(L)}=0\text{V}$, $V_{CTL(H)}=1.8\text{V}$, with application circuit)

| PARAMETERS | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|------------------------|---|-----|------|------|-------|
| Insertion Loss 1 | LOSS1 | f=0.9GHz, $P_{IN}=35\text{dBm}$ | - | 0.25 | 0.45 | dB |
| Insertion Loss 2 | LOSS2 | f=1.9GHz, $P_{IN}=33\text{dBm}$ | - | 0.30 | 0.50 | dB |
| Isolation 1 | ISL1 | f=0.9GHz, $P_{IN}=35\text{dBm}$ | 22 | 25 | - | dB |
| Isolation 2 | ISL2 | f=1.9GHz, $P_{IN}=33\text{dBm}$ | 17 | 20 | - | dB |
| Pin at 0.2dB Compression Point1 | $P_{-0.2\text{dB}}(1)$ | f=1.9GHz | 34 | - | - | dBm |
| 2 nd harmonics1 | $2f_0(1)$ | f=0.9GHz, $P_{IN}=35\text{dBm}$ | - | -75 | -70 | dBc |
| 2 nd harmonics2 | $2f_0(2)$ | f=1.9GHz, $P_{IN}=33\text{dBm}$ | - | -75 | -70 | dBc |
| 3 rd harmonics1 | $3f_0(1)$ | f=0.9GHz, $P_{IN}=35\text{dBm}$ | - | -75 | -70 | dBc |
| 3 rd harmonics2 | $3f_0(2)$ | f=1.9GHz, $P_{IN}=33\text{dBm}$ | - | -75 | -70 | dBc |
| Input 3 rd order intercept point1 | IIP3(1) | f=829+849MHz, $P_{IN}=24\text{dBm}$ each tone *1 | +65 | +70 | - | dBm |
| Input 3 rd order intercept point2 | IIP3(2) | f=1870+1910MHz, $P_{IN}=24\text{dBm}$ each tone *1 | +65 | +70 | - | dBm |
| VSWR | VSWR | on-state ports, f=1.9GHz | - | 1.2 | 1.4 | |
| Switching time | T_{SW} | | - | 1 | 5 | μs |

*1: IIP is defined by the following equation: $IIP3=(3 \times P_{out}-IM3)/2+LOSS$

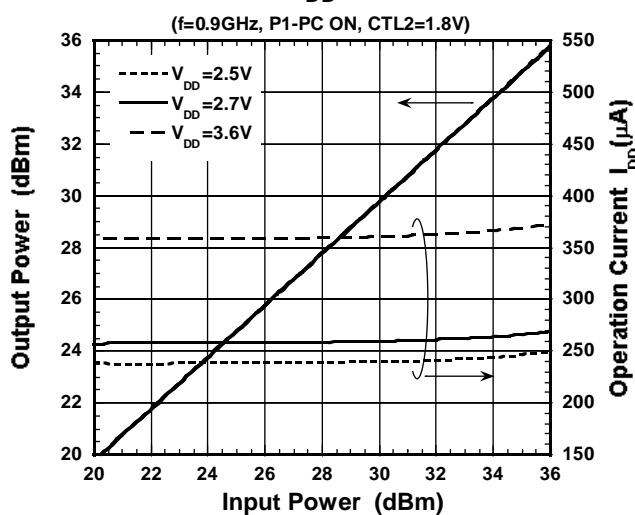
■ TERMINAL INFORMATION

| No. | SYMBOL | DESCRIPTION |
|-----|--------|--|
| 1 | PC | Common RF port. This PC port is connected to P1 or P2 by logical control voltage of CTL1. In order to block DC bias voltage of internal circuit, an external capacitor is required. |
| 2 | CTL2 | Control port 2. This terminal is set to +1.3~5.0V of logical high level as usual, and set to +0.0~0.4V of logical low level for the low current consumption mode. |
| 3 | VDD | Supply voltage terminal (+2.5~3.6V). Please place an inductor close to this terminal, and a bypass capacitor between VDD and GND for avoiding RF characteristic degradation. |
| 4 | CTL1 | Control port 1. This terminal is set to +1.3~5.0V of logical high level for ON state between PC and P1 ports, and set to +0.0~0.4V of logical low level for ON state between PC and P2 RF ports. |
| 5 | P1 | This port is connected with PC port by control voltage of +1.3~5.0V($V_{CTL(H)}$) to 4th pin. An external capacitor is required to block the DC bias voltage of internal circuit. |
| 6 | P2 | This port is connected to PC port by control voltage of +0.0~0.4V($V_{CTL(L)}$) to 4th pin. An external capacitor is required to block the DC bias voltage of internal circuit. |
| GND | GND | Ground terminal. Please connect this terminal with ground plane as close as possible for good RF performance. |

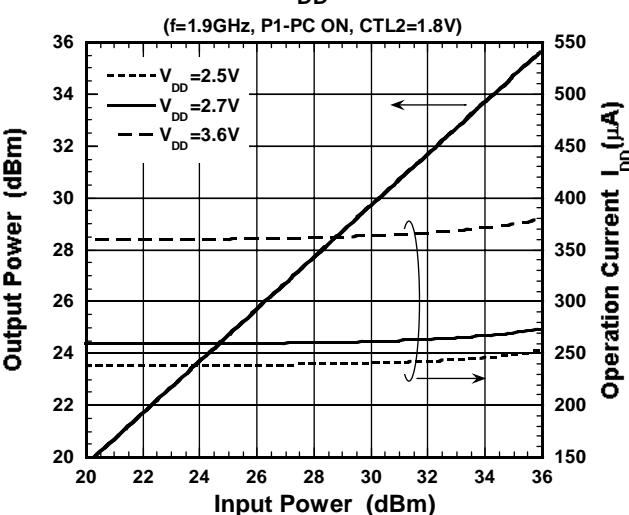
■ ELECTRICAL CHARACTERISTICS (With Application circuit, Loss of external circuit are excluded)**Loss, ISL vs Frequency****Loss, ISL vs Frequency****VSWR vs Frequency****VSWR vs Frequency**

■ ELECTRICAL CHARACTERISTICS (With Application circuit, Loss of external circuit are excluded)

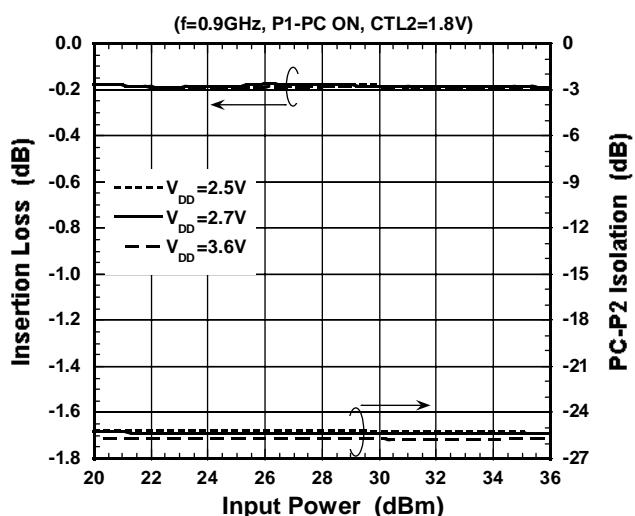
Output Power, I_{DD} vs Input Power



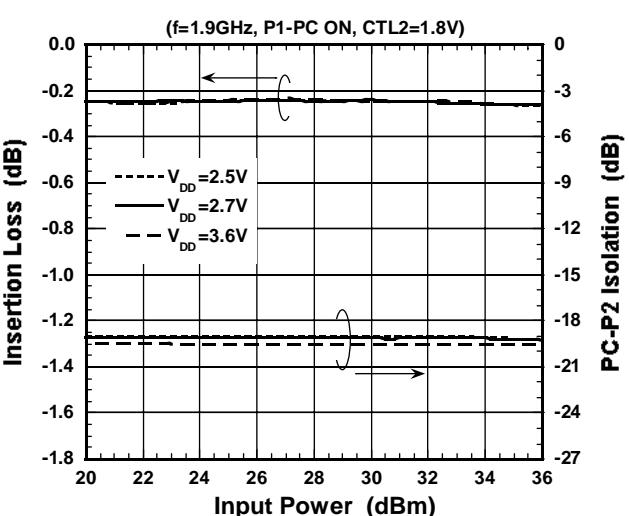
Output Power, I_{DD} vs Input Power



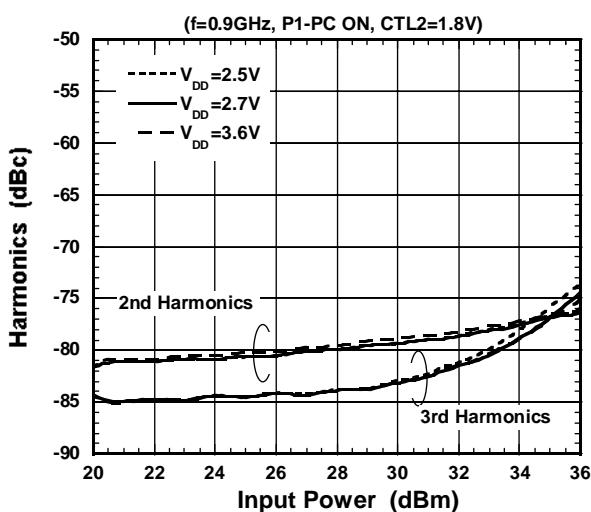
Loss, ISL vs Input Power



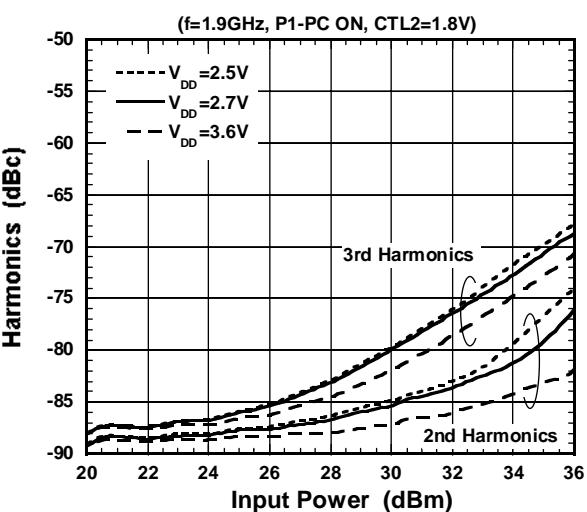
Loss, ISL vs Input Power



Harmonics vs Input Power

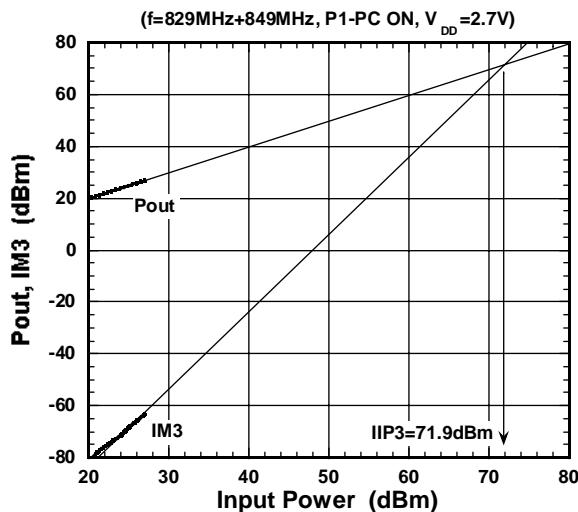


Harmonics vs Input Power

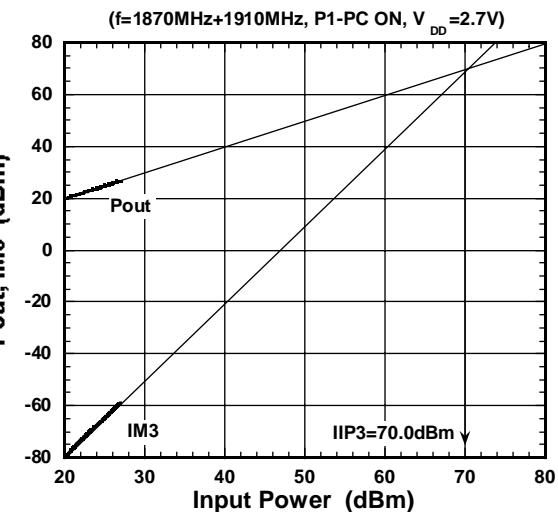


■ ELECTRICAL CHARACTERISTICS (With Application circuit, Loss of external circuit are excluded)

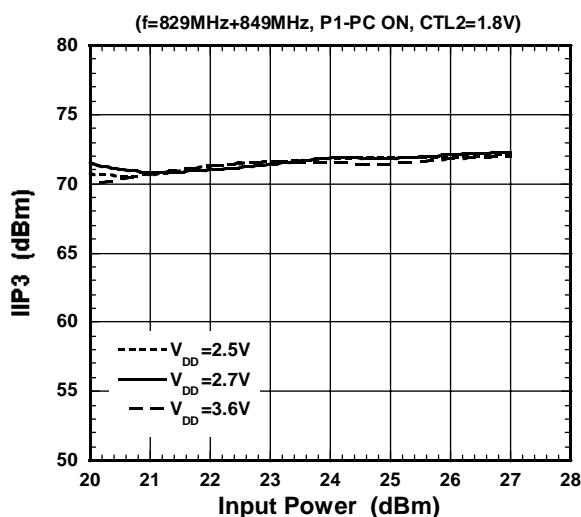
Output Power, IM3 vs Input Power



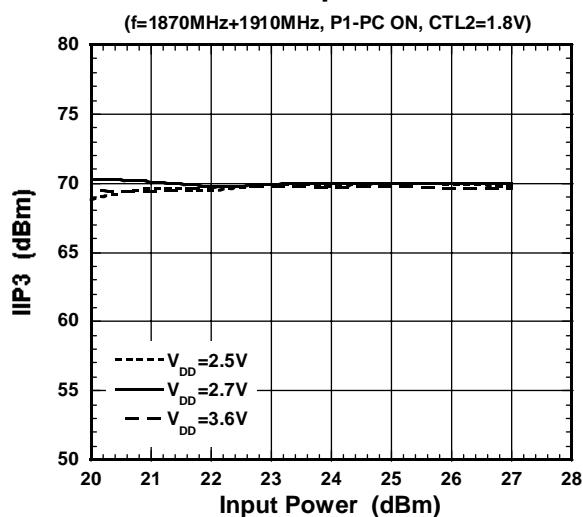
Output Power, IM3 vs Input Power



IIP3 vs Input Power

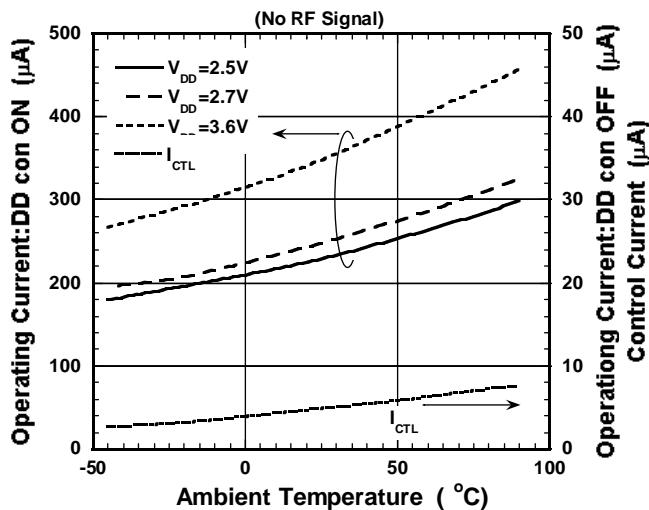


IIP3 vs Input Power

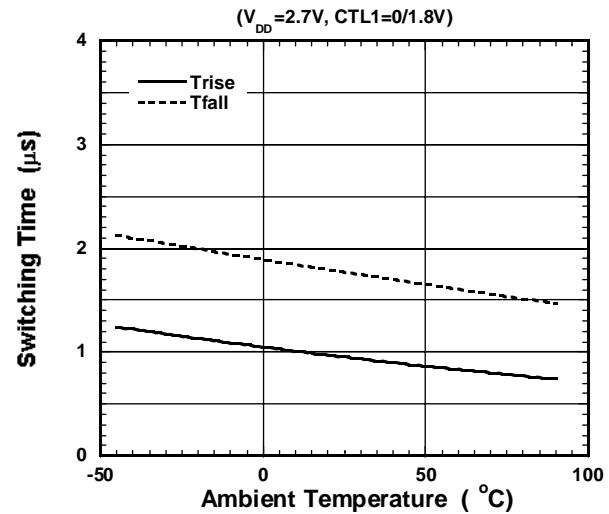


■ ELECTRICAL CHARACTERISTICS (With Application circuit, Loss of external circuit are excluded)

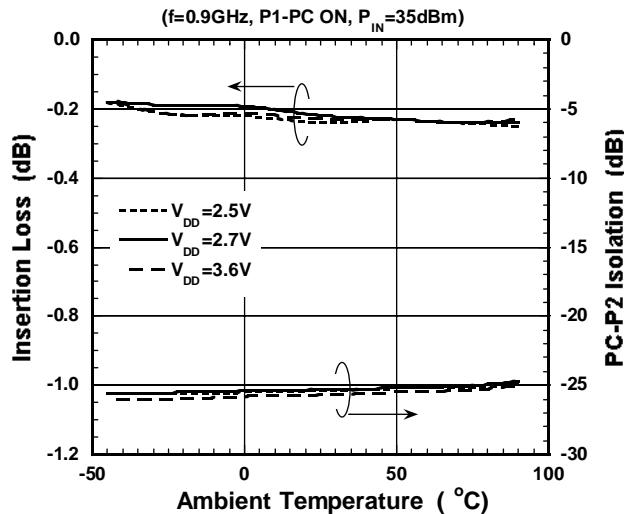
DC Current vs Ambient Temperature



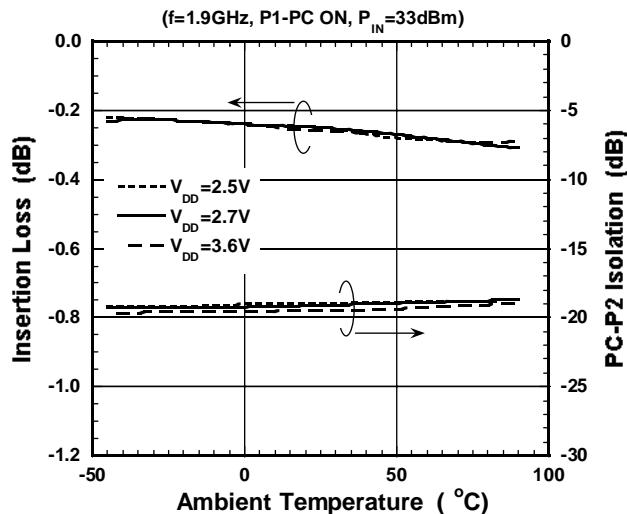
Switching Time vs Ambient Temperature



Loss, ISL vs Ambient Temperature

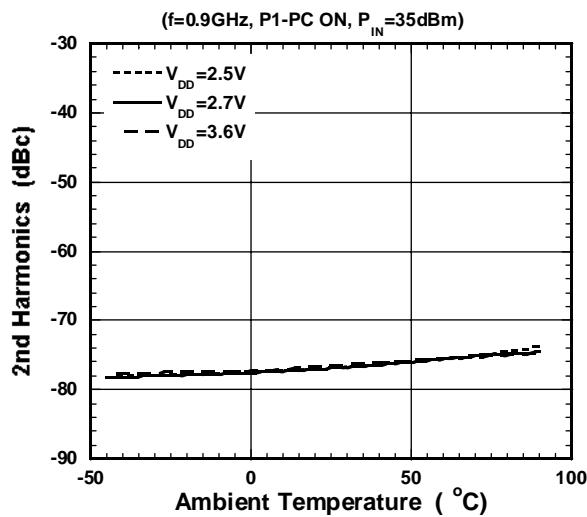


Loss, ISL vs Ambient Temperature

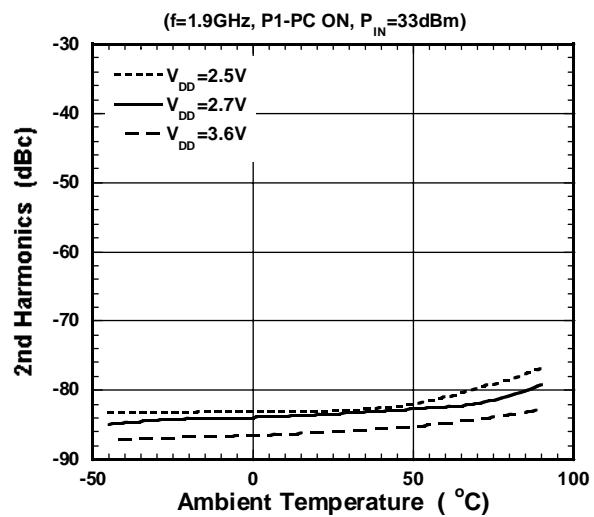


■ ELECTRICAL CHARACTERISTICS (With Application circuit, Loss of external circuit are excluded)

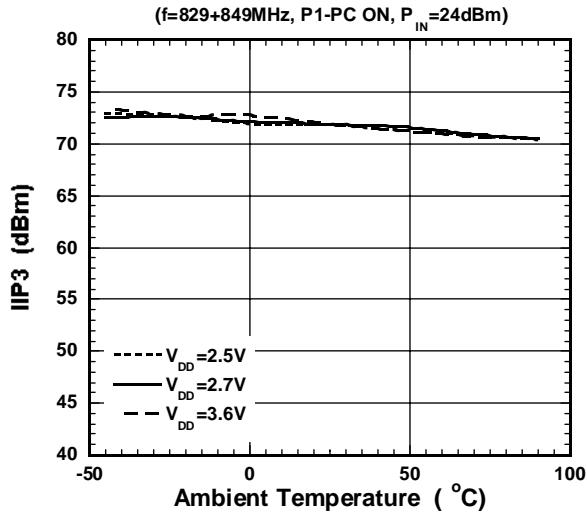
2nd Harmonics vs Ambient Temperature



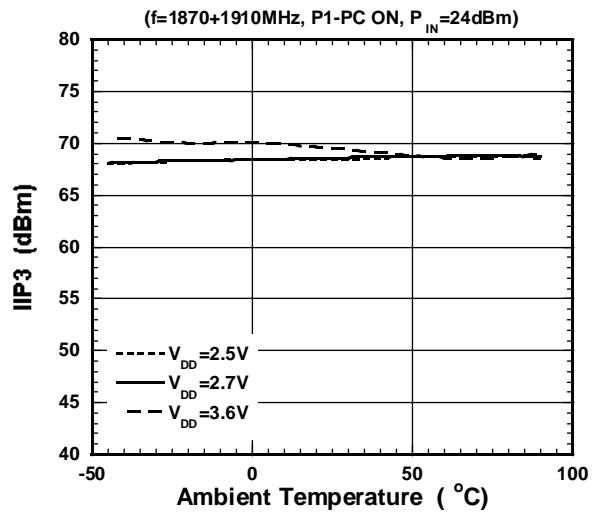
2nd Harmonics vs Ambient Temperature



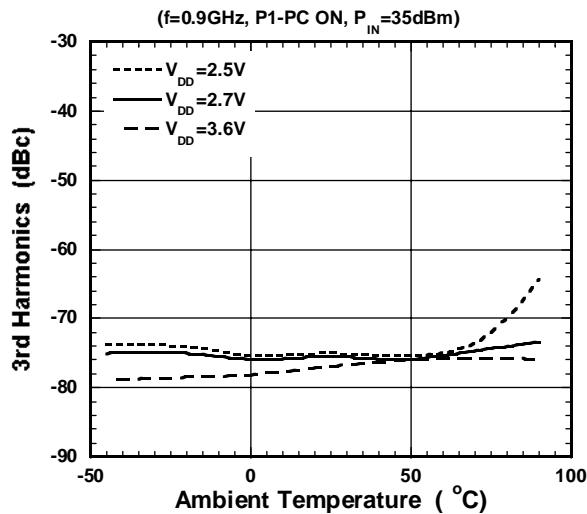
IIP3 vs Ambient Temperature



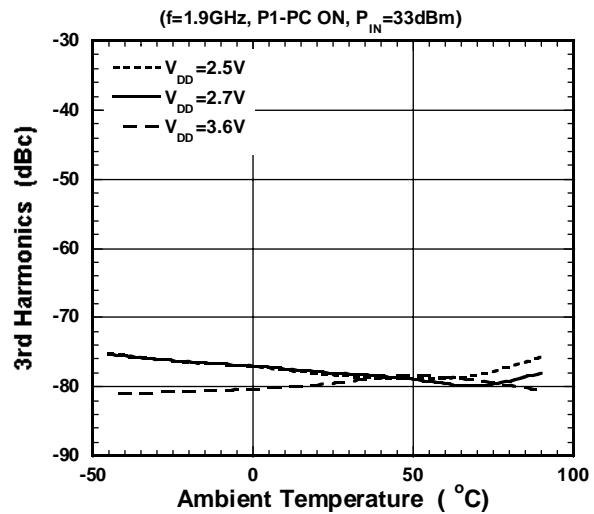
IIP3 vs Ambient Temperature



3rd Harmonics vs Ambient Temperature

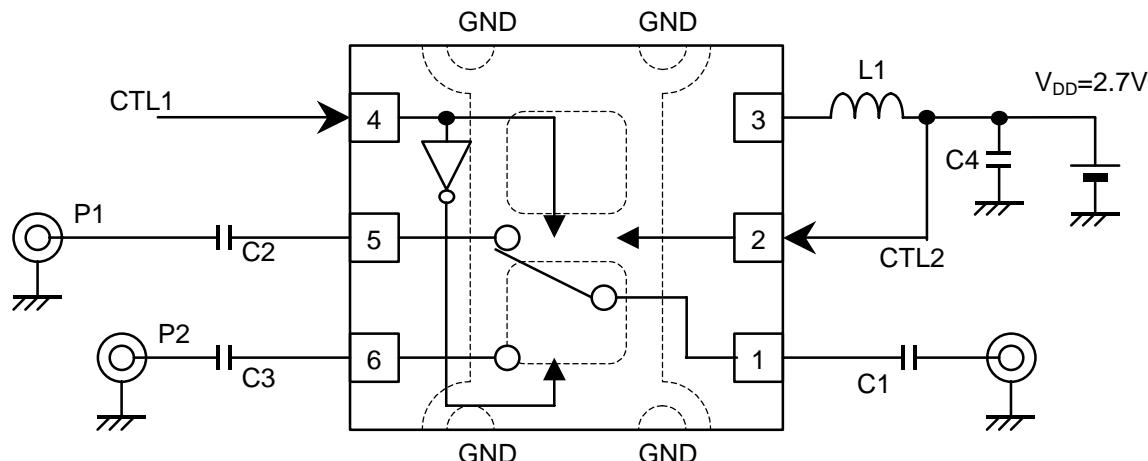


3rd Harmonics vs Ambient Temperature



■ APPLICATION CIRCUIT

(TOP VIEW)

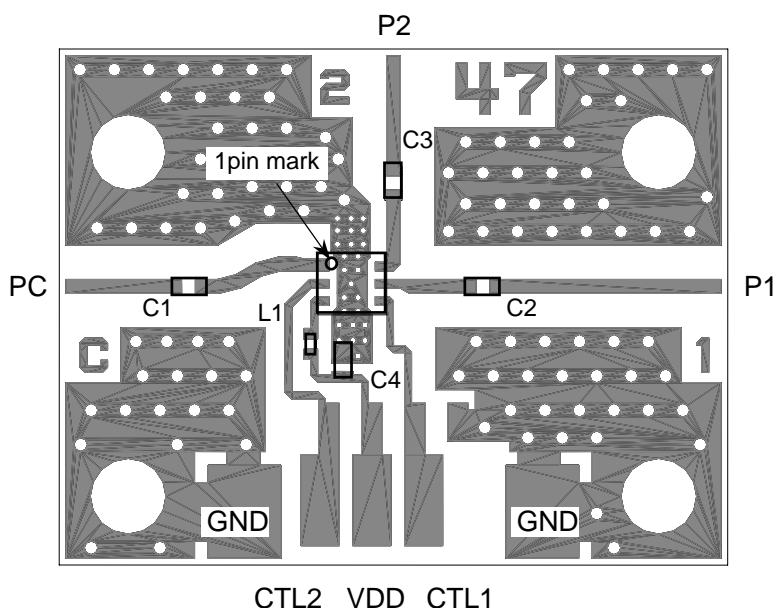


■ PARTS LIST

| No. | Parameters | Note |
|-------|------------|-----------------------|
| C1~C3 | 56pF | Murata MFG (GRM15) |
| C4 | 1000pF | |
| L1 | 82nH | TDK (MLG0603) |

■ TEST PCB LAYOUT

(TOP VIEW)



PCB SIZE=19.4x15.0mm
PCB: FR-4, t=0.2mm
CAPACITOR: size 1005
INDUCTOR: size 0603
Strip Line Width=0.4mm($Z_0=50\Omega$)

■ Losses of PCB

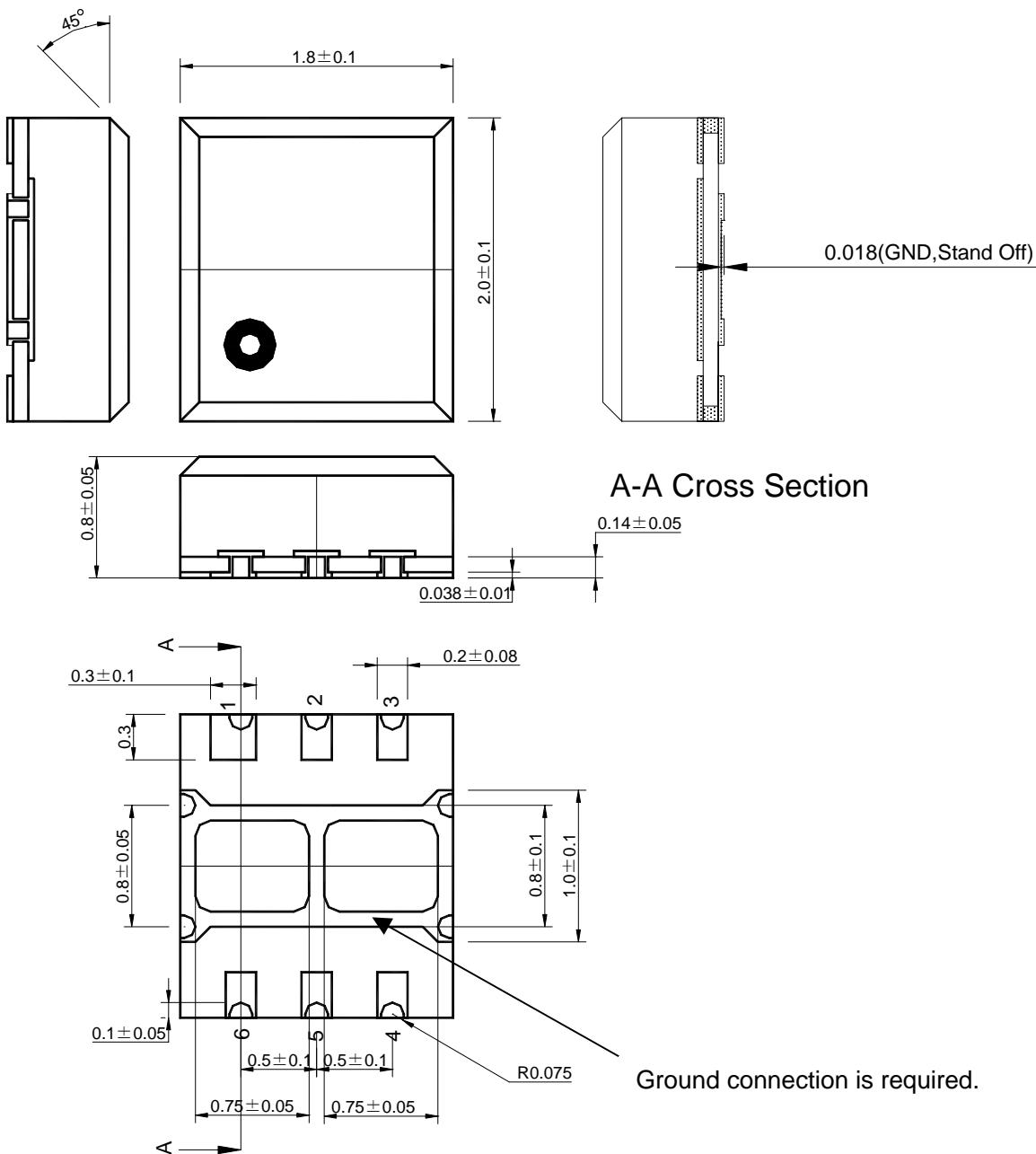
(Connector and DC blocking Capacitor losses are included)

| Frequency (GHz) | Loss (dB) | |
|--------------------|-----------|-------|
| | PC-P1 | PC-P2 |
| 0.9 | 0.23 | 0.21 |
| 1.9 | 0.33 | 0.30 |

PRECAUTIONS

- [1] The DC blocking capacitors have to be placed at RF terminal of PC, P1 and P2.
- [2] To control the influence on the RF performance, the terminal of VDD should be connected with ground through the inductor L1 and the bypass capacitor C4.
- [3] For good RF performance, the ground terminals must be placed possibly close to ground plane of substrate, and through holes for GND should be placed near by the pin connection.

■ PACKAGE OUTLINE (USB6-D3)



Cautions on using this product

This product contains Gallium-Arsenide (GaAs) which is a harmful material.

- Do NOT eat or put into mouth.
- Do NOT dispose in fire or break up this product.
- Do NOT chemically make gas or powder with this product.
- To waste this product, please obey the relating law of your country.

[CAUTION]

The specifications on this databook are only given for information , without any guarantee as regards either mistakes or omissions. The application circuits in this databook are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial rights.

This product may be damaged with electric static discharge (ESD) or spike voltage. Please handle with care to avoid these damages.

ООО "ЛайфЭлектроникс"

"LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

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С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибуторских договоров

Мы предлагаем:

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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помочь разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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